





DUAL SURFACE MOUNT SWITCHING DIODE

Features

- · Fast Switching Speed: Maximum of 4ns
- Low Capacitance: Maximum of 2.0pF
- Small Surface Mount Package
- For General Purpose Switching Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

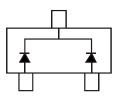
Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, Note
 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe) (3)
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)





Top View



Top View Internal Schematic

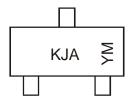
Ordering Information (Notes 4 & 5)

Part Number	Qualification	Case	Packaging
BAV70W-7-F	Commercial	SOT323	3000/Tape & Reel
BAV70WQ-7-F	Automotive	SOT323	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.
- 5. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

Marking Information



KJA = Product Type Marking Code YM = Date Code Marking

Y = Year ex: Z = 2012 M = Month ex: 9 = September

Date Code Key

Year	2000	2001	2002	2003		2012	2013	201	4 201	5 2016	2017	2018	2019
Code	L	М	N	Р		Z	Α	В	С	D	Е	F	G
Month	Jan	Feb	Mar	Apr	Ма	y J	un	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5		6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	100	V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage	$V_{R(RMS)}$	53	V	
Forward Continuous Current (Note 6)	I _{FM}	300	mA	
Non-Repetitive Peak Forward Surge Current (Note 6) @ t = 1.0µs @ t = 1.0x		I _{FSM}	2.0 1.0	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

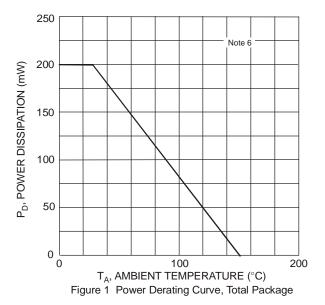
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

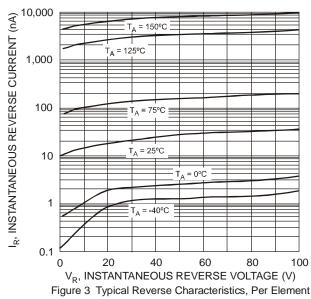
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	75	1	V	$I_R = 100\mu A$
Forward Voltage	V _F		0.715 0.855 1.0 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current (Note 7)	I _R		2.5 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V$, $T_J = +150^{\circ}C$ $V_R = 25V$, $T_J = +150^{\circ}C$ $V_R = 20V$
Total Capacitance	Ст	_	2.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t _{rr}		4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes: 6. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.

^{7.} Short duration pulse test used to minimize self-heating effect.







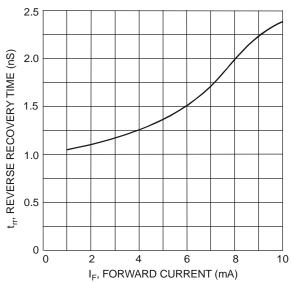
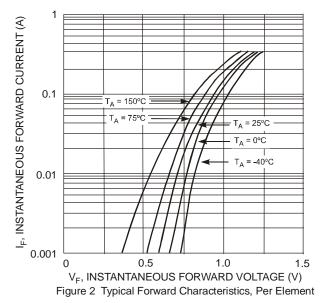


Figure 5 Reverse Recovery Time vs. Forward Current, Per Element



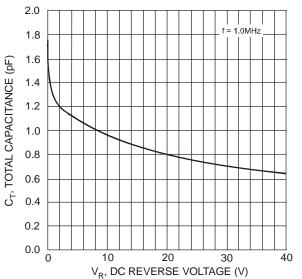
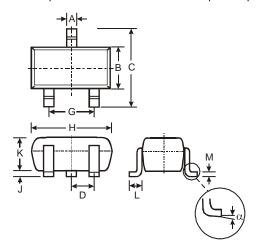


Figure 4 Total Capacitance vs. Reverse Voltage, Per Element



Package Outline Dimensions

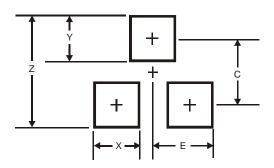
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT323							
Dim	Min	Max	Тур				
Α	0.25	0.40	0.30				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	-	-	0.65				
G	1.20	1.40	1.30				
Н	H 1.80 2.20		2.15				
J	0.0	0.10	0.05				
K	0.90	1.00	1.00				
L	0.25	0.40	0.30				
М	0.10	0.18	0.11				
α	0°	8°	-				
All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0



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 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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